

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	579	528/408.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 13:26
L2	87200	maleic adj anhydride	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 13:26
L3	50	1 and 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 13:34
L4	28217	2 with (polymer or polymeric or oligomer or oligomeric)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 13:59
L5	6	1 and 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 13:38
L6	694	4 same (curing or curative or cured or cure).	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:33
L7	132	6 and (integrated adj circuit or printed adj circuit or electronic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:52
L8	1	6 and underfill	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 13:39
L9	1325	2 with (oligomer or oligomeric)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 13:59

L10	87	9 same (curing or curative or cured or cure)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 13:59
L11	29	10 and (integrated adj circuit or printed adj circuit or electronic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:32
L12	3719	2 same (curing or curative or cured or cure)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:33
L13	10	12 and underfill	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:50
L14	278	12 and (encapsulated or encapsulate or encapsulating)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:52
L15	128	14 and (integrated adj circuit or printed adj circuit or electronic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:51
L16	17091	(integrated adj circuit or printed adj circuit or electronic) same (encapsulating or encapsulated or encapsulate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:53
L17	54	16 and 12	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/30 14:53